

TAIFLEX

2023 Q2 Summer Investment Forum



負責 · 執行 · 創新 · 誠信 · 熱忱

Responsibility · Execution · Creativity · Integrity · Passion



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• Taiflex Profile



Corporate Profile

成立日期 Establishment Date

1997

上市日期 TWSE-listed Date

2009

資本額 Capital (MTWD)

2,091

營業收入 Revenue (MNTD) of 2022

8,722

員工人數 Employees

1,000+

研發投入 Invested in R&D

5% of revenue



Product Portfolio

Taiflex had used its own competitive advantage in chemical recipe and process engineering to provide comprehensive total solution to different industry and thrive to become the leading provider in flexible material in the world

FPC

Display

Thermal

Semi Conductor

Product

- FCCL
- Coverlay
- Bonding Sheet
- Stiffener
- Low Loss Material

- Optical Protection Film
- OCA
- Process Film for OLED

- Thermal Conductive Adhesive
- Metal Core PCB

- Laser De-bond Glue
- UV De-bond Tape

Application

- Smart Phone
- Tablet
- Wearable Device
- Industrial Device
- Medical Device
- Automotive

- Foldable Display
- Touch Panel

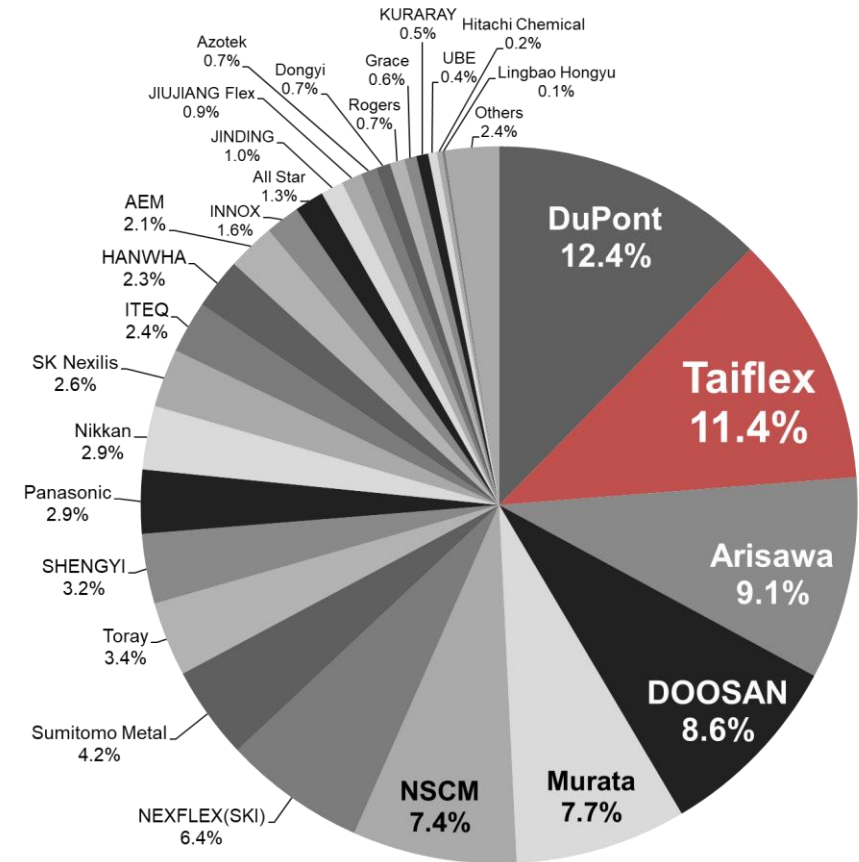
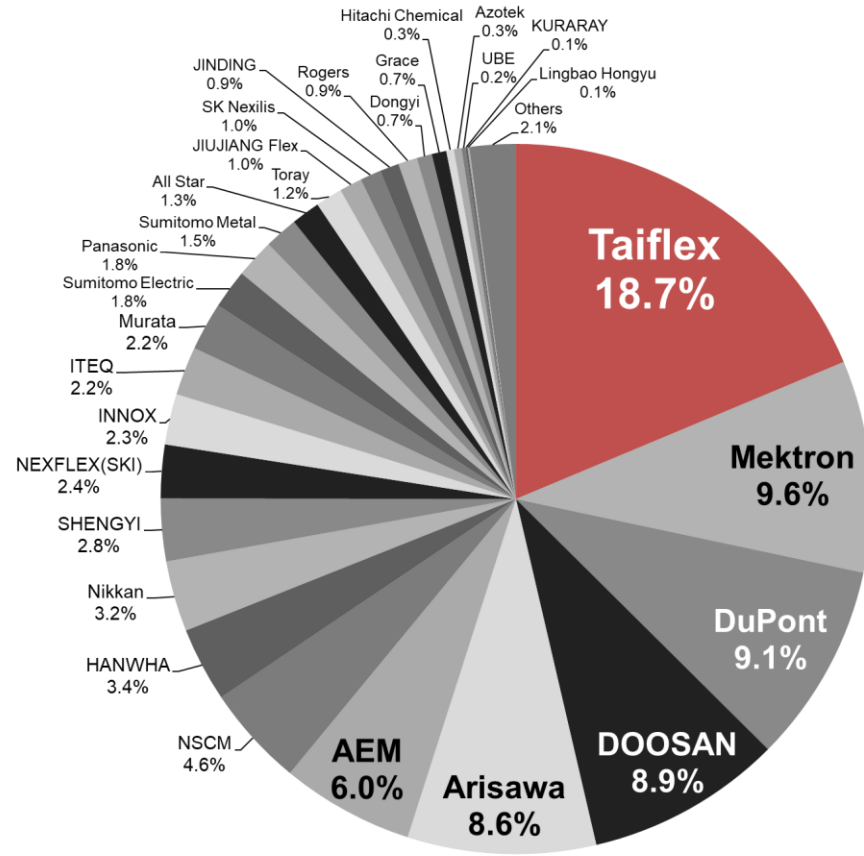
- Car Lighting
- High Power Lighting

- IC Package
- Wafer Dicing

Market Share of FPC Material

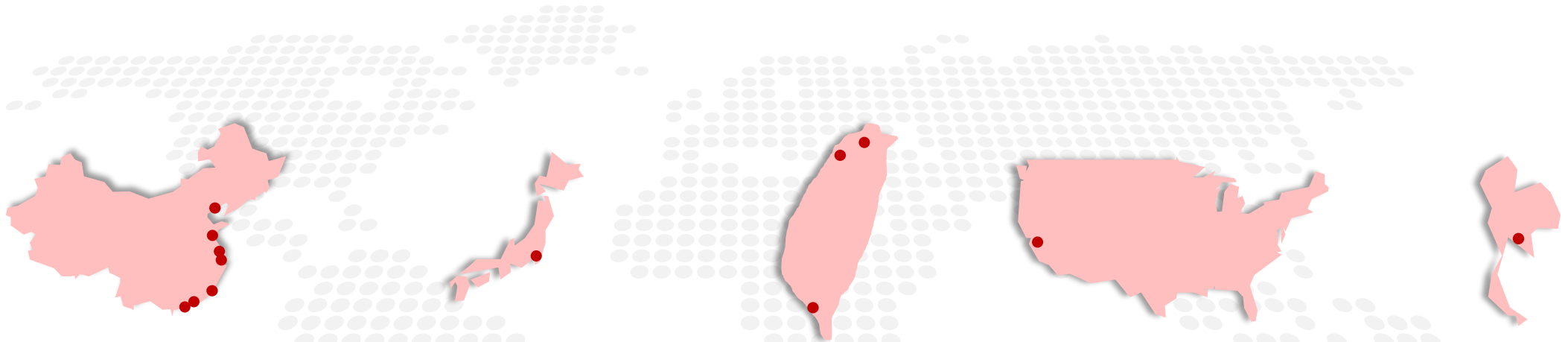
Volume
No. 1

Amount
No. 2



*FPC materials include 2L/3L FCCL, Coverlay, BS, Stiffener, PP and others.

Production Base and Sales Office



Mainland China

Production Base

- Rudong

Office Location

- Qinhuangdao
- Kunshan
- Huaian
- Xiamen
- Shenzhen
- Zhuhai

Japan

Subsidiary

- Tokyo

Taiwan

Production Base

- Kaohsiung (HQ)
- Hsinchu (KTC)

Office Location

- New Taipei City

USA

Subsidiary

- San Jose

Thailand

Production Base

- Under Planning
(Mid-2024 MP)

COMING
SOON

PART 2 Operation Outlook

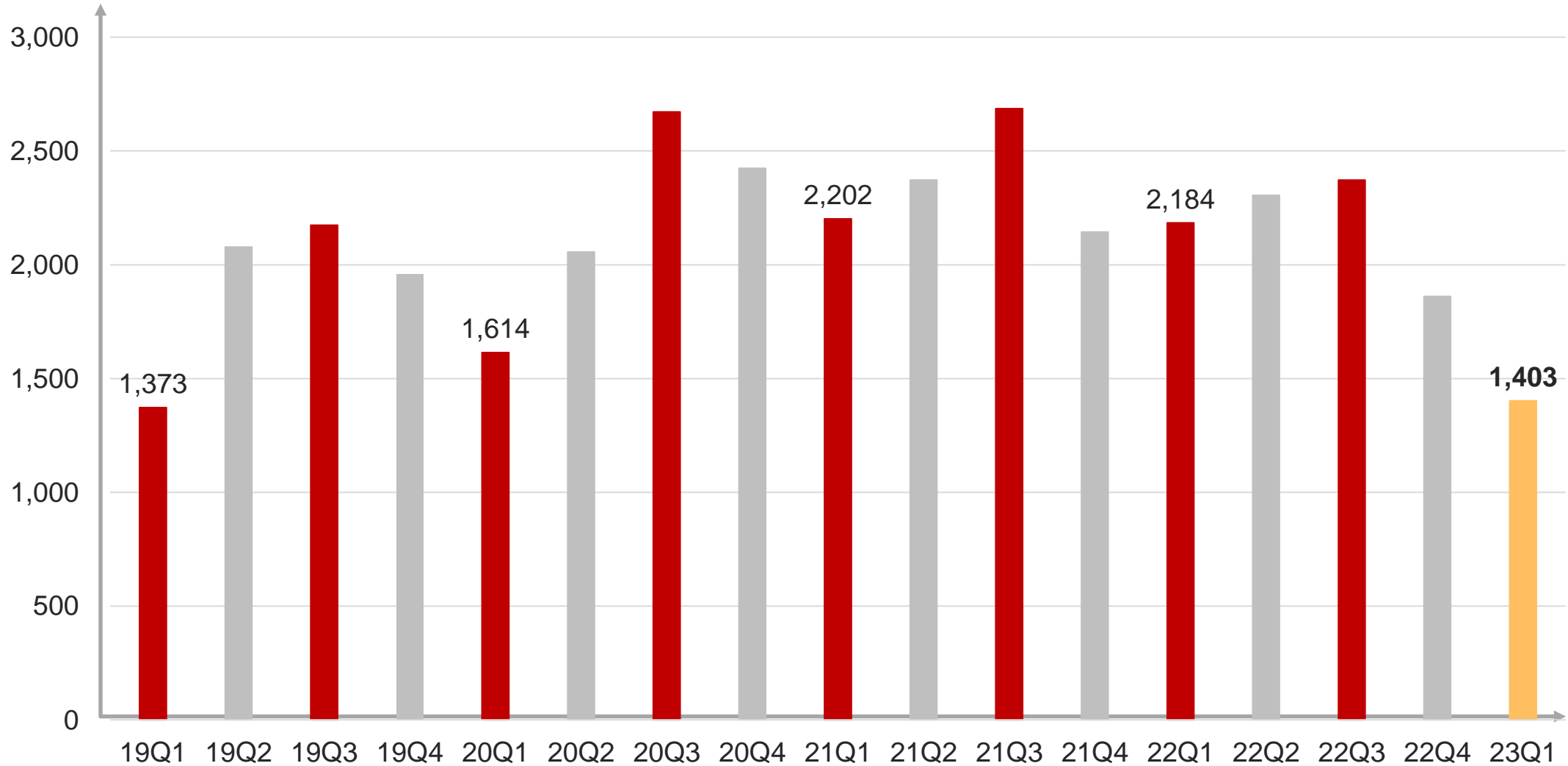




Corporate Revenue

Security D
Unrestricted

Unit : NT\$ million



Market Outlook



Phone



NB/Tablet



Automotive



Wearable



AR/VR

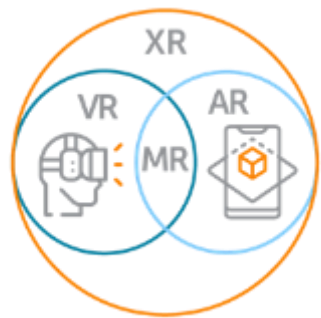
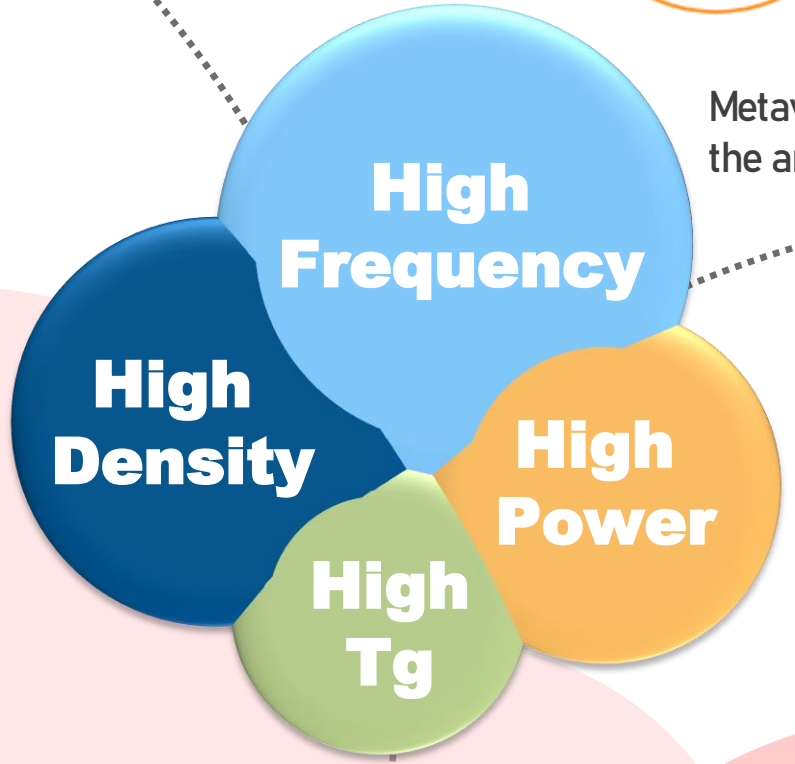
QoQ



YoY



New Application



Metaverse AR/VR/MR/XR

Metaverse drives the development of AR/VR, and the amount of flexible boards grows



Phone / Pad / Laptop

High Frequency / Thick Copper Thick PI / High Density FCCL /
Low ionic adhesives increase market share

Electric Vehicle

Electric vehicles will grow 11 times in the next 10 years, and the amount of FPC per vehicle will exceed 100 pieces

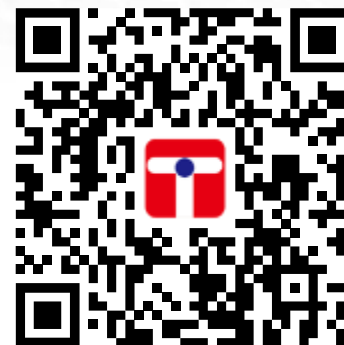
Questions & Answers





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<https://www.taiflex.com.tw>

台虹科技股份有限公司
TAIFLEX SCIENTIFIC CO., LTD.

深圳台虹电子有限公司
SHENZHEN TAIFLEX ELECTRONIC CO.,LTD.

昆山瀚虹兴电子有限公司
KUN SHAN TAIFLEX ELECTRONIC CO.,LTD.

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RUDONG FUZHAN SCIENTIFIC CO.,LTD.



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